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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Obsolete
Core Processor	80C51
Core Size	8-Bit
Speed	30/20MHz
Connectivity	UART/USART
Peripherals	POR
Number of I/O	32
Program Memory Size	8KB (8K x 8)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	44-LCC (J-Lead)
Supplier Device Package	44-PLCC (16.6x16.6)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/ts87c52x2-lcb

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SFR Mapping

The Special Function Registers (SFRs) of the TS80C52X2 fall into the following categories:

- C51 core registers: ACC, B, DPH, DPL, PSW, SP, AUXR1
- I/O port registers: P0, P1, P2, P3
- Timer registers: T2CON, T2MOD, TCON, TH0, TH1, TH2, TMOD, TL0, TL1, TL2, RCAP2L, RCAP2H
- Serial I/O port registers: SADDR, SADEN, SBUF, SCON
- Power and clock control registers: PCON
- Interrupt system registers: IE, IP, IPH
- Others: AUXR, CKCON





Table 2. All SFRs with their address and their reset value

	Bit Addressable			Nc	on Bit Addressal	ble			
	0/8	1/9	2/A	3/B	4/C	5/D	6/E	7/F	
F8h									FFh
F0h	B 0000 0000								F7h
E8h									EFh
E0h	ACC 0000 0000								E7h
D8 h									DFh
D0 h	PSW 0000 0000								D7h
C8 h	T2CON 0000 0000	T2MOD XXXX XX00	RCAP2L 0000 0000	RCAP2H 0000 0000	TL2 0000 0000	TH2 0000 0000			CFh
C0 h									C7h
B8h	IP XX00 0000	SADEN 0000 0000							BFh
B0h	P3 1111 1111							IPH XX00 0000	B7h
A8h	IE 0X00 0000	SADDR 0000 0000							AFh
A0h	P2 1111 1111		AUXR1 XXXX XXX0						A7h
98h	SCON 0000 0000	SBUF XXXX XXXX							9Fh
90h	P1 1111 1111								97h
88h	TCON 0000 0000	TMOD 0000 0000	TL0 0000 0000	TL1 0000 0000	TH0 0000 0000	TH1 0000 0000	AUXR XXXXXXX0	CKCON XXXX XXX0	8Fh
80h	P0 1111 1111	SP 0000 0111	DPL 0000 0000	DPH 0000 0000				PCON 00X1 0000	87h
	0/8	1/9	2/A	3/B	4/C	5/D	6/E	7/F	

Reserved



Dual Data Pointer Register (Ddptr)

The additional data pointer can be used to speed up code execution and reduce code size in a number of ways.

The dual DPTR structure is a way by which the chip will specify the address of an external data memory location. There are two 16-bit DPTR registers that address the external memory, and a single bit called

DPS = AUXR1/bit0 (See Table 5.) that allows the program code to switch between them (Refer to Figure 3).

Figure 3. Use of Dual Pointer

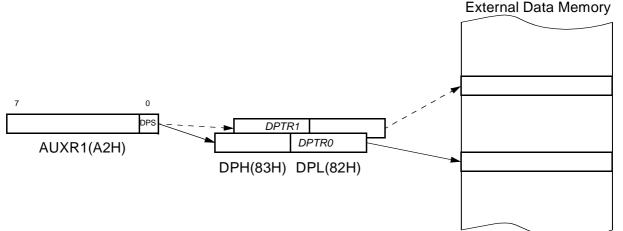
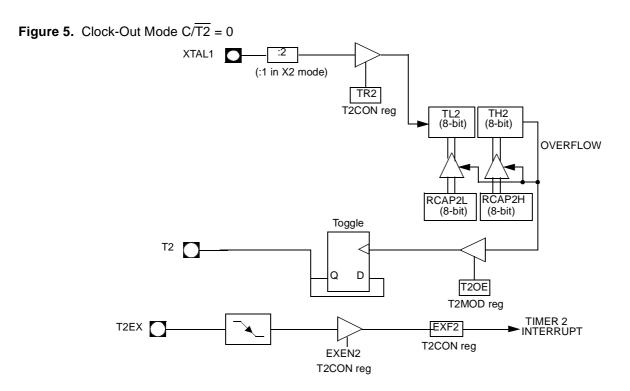


Table 4. AUXR1: Auxiliary Register 1

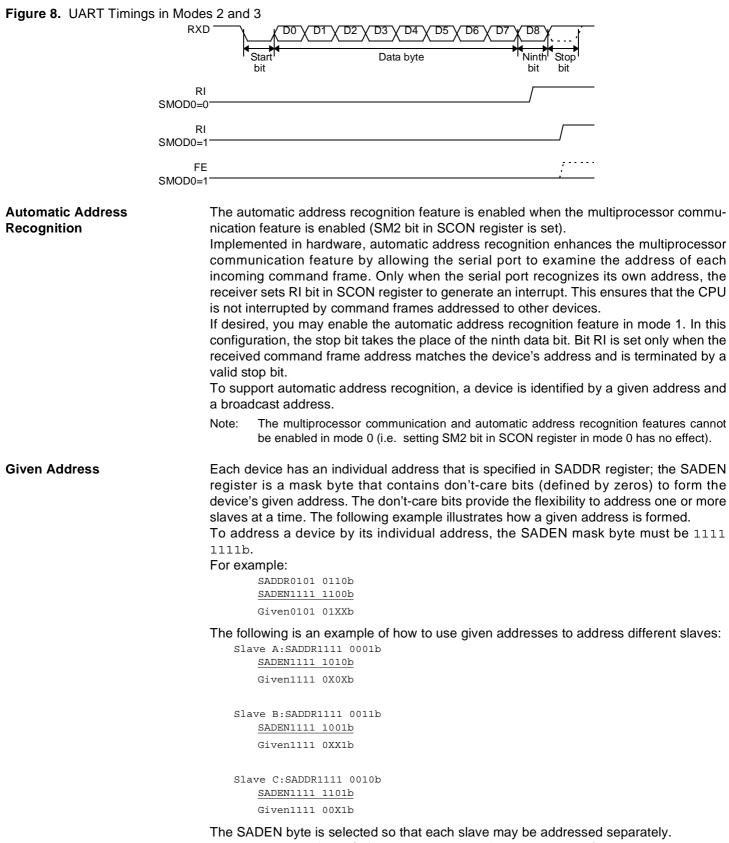
7	6	5	4	3	2	1	0	
-	-	-	-	GF3	0	-	DPS	
Bit Number	Bit Mnemonic	Description	ı					
7	-	Reserved The value re	ead from this	bit is indeterm	inate. Do not	set this bit.		
6	-	Reserved The value re	ead from this	bit is indeterm	inate. Do not	set this bit.		
5	-	Reserved The value re	ead from this	bit is indeterm	inate. Do not	set this bit.		
4	-	Reserved The value re	ead from this	bit is indeterm	inate. Do not	set this bit.		
3	GF3	This bit is a	general purp	ose user flag				
2	0	Reserved Always stud	k at 0					
1	-	Reserved The value re	Reserved The value read from this bit is indeterminate. Do not set this bit.					
0	DPS	Data Pointe Clear to select Set to select						

Reset Value = XXXX XXX0 Not bit addressable









For slave A, bit 0 (the LSB) is a don't-care bit; for slaves B and C, bit 0 is a 1. To communicate with slave A only, the master must send an address where bit 0 is clear (e.g.

18 **TS8xCx2X2**

1111 0000b).
For slave A, bit 1 is a 1; for slaves B and C, bit 1 is a don't care bit. To communicate with slaves B and C, but not slave A, the master must send an address with bits 0 and 1 both set (e.g. 1111 0011b).
To communicate with slaves A, B and C, the master must send an address with bit 0 set, bit 1 clear, and bit 2 clear (e.g. 1111 0001b).

Broadcast Address A broadcast address is formed from the logical OR of the SADDR and SADEN registers with zeros defined as don't-care bits, e.g.:

SADDR 0101 0110b SADEN 1111 1100b Broadcast =SADDR OR SADEN1111 111Xb

The use of don't-care bits provides flexibility in defining the broadcast address, however in most applications, a broadcast address is FFh. The following is an example of using broadcast addresses:

Slave A:SADDR1111 0001b <u>SADEN1111 1010b</u> Broadcast1111 1X11b, Slave B:SADDR1111 0011b <u>SADEN1111 1001b</u> Broadcast1111 1X11B,

Slave C:SADDR=1111 0010b <u>SADEN1111 1101b</u> Broadcast1111 1111b

For slaves A and B, bit 2 is a don't care bit; for slave C, bit 2 is set. To communicate with all of the slaves, the master must send an address FFh. To communicate with slaves A and B, but not slave C, the master can send and address FBh.

Reset AddressesOn reset, the SADDR and SADEN registers are initialized to 00h, i.e. the given and
broadcast addresses are XXXX XXXb (all don't-care bits). This ensures that the serial
port will reply to any address, and so, that it is backwards compatible with the 80C51
microcontrollers that do not support automatic address recognition.

 Table 7.
 SADEN Register

7	6	5	4	3	2	1	0
Decet Valu		0006			<u>.</u>		
Reset Valu		0000					
Not bit add	ressable						
Table 8 S		vietor					
	-						
	-		er (A9h)				
Table 8. S SADDR - S 7	-		er (A9h) 4	3	2	1	0
SADDR - S	lave Addre	ess Registe	er (A9h) 4	3	2	1	0
SADDR - S	lave Addre	ess Registe	er (A9h) 4	3	2	1	0

Not bit addressable





Table 9.SCON RegisterSCON - Serial Control Register (98h)

7	6	5	4	3	2	1	0		
FE/SM0	SM1	SM2	REN	TB8	RB8	TI	RI		
Bit Number	Bit Mnemonic	Description							
7	FE	Clear to reset Set by hardwa	raming Error bit (SMOD0=1) lear to reset the error state, not cleared by a valid stop bit. et by hardware when an invalid stop bit is detected. MOD0 must be set to enable access to the FE bit						
	SM0	Serial port Mo Refer to SM1 SMOD0 must	for serial port		tion. ess to the SM0 b	it			
6	SM1	Serial port Mo SM0 SM1 0 0 0 1 1 0 1 1	ModeDesc0Shift18-bit29-bit	Register F UART \ UART F	aud Rate _{XTAL} /12 (/6 in X2 'ariable _{XTAL} /64 or F _{XTAL} / 'ariable		n X2 mode)		
5	SM2	Clear to disab Set to enable	le multiproces multiprocesso	sor commu r communic	or Communicat nication feature. ation feature in r eared in mode (node 2 and 3,			
4	REN	Reception En Clear to disab Set to enable	le serial recep						
3	TB8	Transmitter Bi Clear to transr Set to transmi	nit a logic 0 in	the 9th bit.	n modes 2 and 3	i.			
2	RB8	Cleared by ha Set by hardwa	Receiver Bit 8 / Ninth bit received in modes 2 and 3 Cleared by hardware if 9th bit received is a logic 0. Set by hardware if 9th bit received is a logic 1. In mode 1, if SM2 = 0, RB8 is the received stop bit. In mode 0 RB8 is not used.						
1	ті	Clear to acknown Set by hardward	Transmit Interrupt flag Clear to acknowledge interrupt. Set by hardware at the end of the 8th bit time in mode 0 or at the beginning of the stop bit in the other modes.						
0	RI	Clear to acknown Set by hardward	Receive Interrupt flag Clear to acknowledge interrupt. Set by hardware at the end of the 8th bit time in mode 0, see Figure 7. and Figure 3. in the other modes.						

Reset Value = 0000 0000b Bit addressable

Table 10. PCON RegisterPCON - Power Control Register (87h)

7	6	5	4	3	2	1	0
SMOD1	SMOD0	-	POF	GF1	GF0	PD	IDL
Bit Number	Bit Mnemonic	Descriptio	n				
7	SMOD1		t Mode bit 1 act double bau	ud rate in mode	e 1, 2 or 3.		
6	SMOD0	Clear to se		n SCON regist SCON registe			
5	-	Reserved The value	read from this	bit is indeterm	ninate. Do not	set this bit.	
4	POF		cognize next i dware when V	reset type. /CC rises from	0 to its nomina	al voltage. Ca	n also be set
3	GF1	Cleared by		eral purpose us purpose usage			
2	GF0	Cleared by	-	eral purpose us purpose usage	-		
1	PD	Cleared by	wn mode bit hardware wh r power-down	ien reset occui n mode.	rs.		
0	IDL	-		i interrupt or re	eset occurs.		

Reset Value = 00X1 0000b Not bit addressable

Power-off flag reset value will be 1 only after a power on (cold reset). A warm reset doesn't affect the value of this bit.



are received simultaneously, an internal polling sequence determines which request is serviced. Thus within each priority level there is a second priority structure determined by the polling sequence.

Table 12. IE Register

IE - Interrupt Enable Register (A8h)

7	6	5	4	3	2	1	0		
EA	-	ET2	ES	ET1	EX1	ET0	EX0		
Bit Number	Bit Mnemonic	Description							
7	EA	Clear to disab Set to enable If EA=1, each	inable All interrupt bit Clear to disable all interrupts. Set to enable all interrupts. EA=1, each interrupt source is individually enabled or disabled by setting or learing its own interrupt enable bit.						
6	-	Reserved The value read	d from this bit	is indetermina	ate. Do not se	t this bit.			
5	ET2	Timer 2 overf Clear to disab Set to enable	le timer 2 ove	rflow interrupt					
4	ES	Serial port Er Clear to disab Set to enable	le serial port i	•					
3	ET1	Timer 1 overf Clear to disab Set to enable	le timer 1 ove	rflow interrupt					
2	EX1	Clear to disab	External interrupt 1 Enable bit Clear to disable external interrupt 1. Set to enable external interrupt 1.						
1	ET0	Clear to disab	Timer 0 overflow interrupt Enable bit Clear to disable timer 0 overflow interrupt. Set to enable timer 0 overflow interrupt.						
0	EX0	Clear to disab	External interrupt 0 Enable bit Clear to disable external interrupt 0. Set to enable external interrupt 0.						

Reset Value = 0X00 0000b Bit addressable



Table 14.IPH RegisterIPH - Interrupt Priority High Register (B7h)

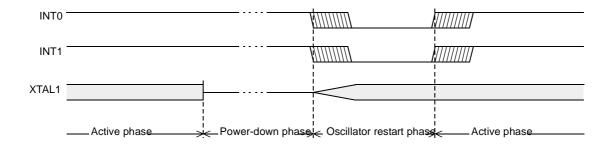
7	6	5	4	3	2	1	0
-	-	PT2H	PSH	PT1H	PX1H	РТОН	РХОН
Bit Number	Bit Mnemonic	Description					
7	-	Reserved The value rea	d from this bit	is indetermina	ate. Do not se	t this bit.	
6	-	Reserved The value rea	d from this bit	is indetermina	ate. Do not se	t this bit.	
5	PT2H	Timer 2 over PT2H PT2 0 0 1 0 1 1	f low interrup <u>Priority Leve</u> Lowest Highest	t Priority High 한	n bit		
4	PSH	Serial port P PSH PS 0 0 0 1 1 0 1 1	riority High b <u>Priority Leve</u> Lowest Highest				
3	PT1H	Timer 1 over PT1H PT1 0 0 0 1 1 0 1 1		t Priority High 키	n bit		
2	PX1H	External inte PX1H PX1 0 0 1 0 1 1 1 1	rrupt 1 Priori Priority Leve Lowest Highest				
1	РТОН	Timer 0 over PT0H PT0 0 0 1 0 1 1		t Priority High 한	n bit		
0	РХОН	External inte PX0H PX0 0 0 1 1 1 1	rrupt 0 Priori <u>Priority Leve</u> Lowest Highest	ty High bit <u>키</u>			

Reset Value = XX00 0000b Not bit addressable



Idle mode	An instruction that sets PCON.0 causes that to be the last instruction executed before going into the Idle mode. In the Idle mode, the internal clock signal is gated off to the CPU, but not to the interrupt, Timer, and Serial Port functions. The CPU status is pre- served in its entirely : the Stack Pointer, Program Counter, Program Status Word, Accumulator and all other registers maintain their data during Idle. The port pins hold the logical states they had at the time Idle was activated. ALE and PSEN hold at logic high levels.
	There are two ways to terminate the Idle. Activation of any enabled interrupt will cause PCON.0 to be cleared by hardware, terminating the Idle mode. The interrupt will be serviced, and following RETI the next instruction to be executed will be the one following the instruction that put the device into idle.
	The flag bits GF0 and GF1 can be used to give an indication if an interrupt occured dur- ing normal operation or during an Idle. For example, an instruction that activates Idle can also set one or both flag bits. When Idle is terminated by an interrupt, the interrupt service routine can examine the flag bits.
	The other way of terminating the Idle mode is with a hardware reset. Since the clock oscillator is still running, the hardware reset needs to be held active for only two machine cycles (24 oscillator periods) to complete the reset.
Power-down Mode	To save maximum power, a power-down mode can be invoked by software (Refer to Table 10., PCON register).
	In power-down mode, the oscillator is stopped and the instruction that invoked power- down mode is the last instruction executed. The internal RAM and SFRs retain their value until the power-down mode is terminated. V_{CC} can be lowered to save further power. Either a hardware reset or an external interrupt can cause an exit from power- down. To properly terminate power-down, the reset or external interrupt should not be executed before V_{CC} is restored to its normal operating level and must be held active long enough for the oscillator to restart and stabilize.
	Only external interrupts INT0 and INT1 are useful to exit from power-down. For that, interrupt must be enabled and configured as level or edge sensitive interrupt input. Holding the pin low restarts the oscillator but bringing the pin high completes the exit as detailed in Figure 10. When both interrupts are enabled, the oscillator restarts as soon as one of the two inputs is held low and power down exit will be completed when the first input will be released. In this case the higher priority interrupt service routine is executed.
	Once the interrupt is serviced, the next instruction to be executed after RETI will be the one following the instruction that put TS80C52X2 into power-down mode.
Figure 10. Power-down Exit Wa	veform

MEI



Power-off Flag

The power-off flag allows the user to distinguish between a "cold start" reset and a "warm start" reset.

A cold start reset is the one induced by V_{CC} switch-on. A warm start reset occurs while V_{CC} is still applied to the device and could be generated for example by an exit from power-down.

The power-off flag (POF) is located in PCON register (See Table 17.). POF is set by hardware when V_{CC} rises from 0 to its nominal voltage. The POF can be set or cleared by software allowing the user to determine the type of reset.

The POF value is only relevant with a Vcc range from 4.5V to 5.5V. For lower Vcc value, reading POF bit will return indeterminate value.

7	6	Register 5	4	3	2	1	0	
SMOD1	SMOD0	-	POF	GF1	GF0	PD	IDL	
Bit Number	Bit Mnemonic	Descript	on					
7	SMOD1		Serial port Mode bit 1 Set to select double baud rate in mode 1, 2 or 3.					
6	SMOD0	Clear to s) t in SCON regi n SCON regis				
5	-		Reserved The value read from this bit is indeterminate. Do not set this bit.					
4	POF		ecognize nex rdware when	t reset type. V _{CC} rises from	n 0 to its nomii	nal voltage. Ca	an also be	
3	GF1	Cleared b) neral purpose l purpose usag				
2	GF0	Cleared b	General purpose Flag Cleared by user for general purpose usage. Set by user for general purpose usage.					
1	PD	Cleared b	own mode bi by hardware v er power-dov	when reset occ	surs.			
0	IDL			en interrupt or	reset occurs.			

 Table 17.
 PCON Register

PCON - Power Control Register (87h)

Reset Value = 00X1 0000b Not bit addressable





Reduced EMI Mode

The ALE signal is used to demultiplex address and data buses on port 0 when used with external program or data memory. Nevertheless, during internal code execution, ALE signal is still generated. In order to reduce EMI, ALE signal can be disabled by setting AO bit.

The AO bit is located in AUXR register at bit location 0. As soon as AO is set, ALE is no longer output but remains active during MOVX and MOVC instructions and external fetches. During ALE disabling, ALE pin is weakly pulled high.

Table 18. AUXR Register

AUXR - Auxiliary Register (8Eh)

7	6	5	4	3	2	1	0	
-	-	-	-	-	-	-	AO	
Bit Number	Bit Mnemonic	Description						
7	-	Reserved The value rea	ad from this b	it is indetermi	nate. Do not s	et this bit.		
6	-	Reserved The value rea	ad from this b	it is indetermi	nate. Do not s	et this bit.		
5	-	Reserved The value rea	ad from this b	it is indetermi	nate. Do not s	et this bit.		
4	-	Reserved The value rea	ad from this b	it is indetermi	nate. Do not s	et this bit.		
3	-	Reserved The value rea	ad from this b	it is indetermi	nate. Do not s	et this bit.		
2	-	Reserved The value rea	ad from this b	it is indetermi	nate. Do not s	et this bit.		
1	-	Reserved The value rea	Reserved The value read from this bit is indeterminate. Do not set this bit.					
0	AO		ore ALE operation	ation during in ion during inte				

Reset Value = XXXX XXX0b Not bit addressable

Control and program signals must be held at the levels indicated in Table 35.

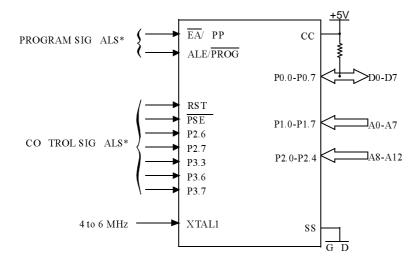
Definition of terms

Address Lines: P1.0-P1.7, P2.0-P2.4 respectively for A0-A12 Data Lines: P0.0-P0.7 for D0-D7 Control Signals: RST, PSEN, P2.6, P2.7, P3.3, P3.6, P3.7. Program Signals: ALE/PROG, EA/VPP.

Table 20. EPROM Set-up Modes

Mode	RST	PSEN	ALE/ PROG	EA/ VPP	P2.6	P2.7	P3.3	P3.6	P3.7
Program Code data	1	0	IJ	12.75V	0	1	1	1	1
Verify Code data	1	0	1	1	0		0	1	1
Program Encryption Array Address 0-3Fh	1	0	U	12.75V	0	1	1	0	1
Read Signature Bytes	1	0	1	1	0		0	0	0
Program Lock bit 1	1	0	ប	12.75V	1	1	1	1	1
Program Lock bit 2	1	0	ъ	12.75V	1	1	1	0	0
Program Lock bit 3	1	0	Ъ	12.75V	1	0	1	1	0

Figure 11. Set-Up Modes Configuration



* See Table 31. for proper value on these inputs



Table 22. DC Parameters in Standard Voltage (Continued	Table 22.	tage (Continued)
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Symbol	Parameter	Min	Тур	Мах	Unit	Test Conditions
V _{OH}	Output High Voltage, ports 1, 2, 3	V _{CC} - 0.3 V _{CC} - 0.7 V _{CC} - 1.5			V V V	I _{OH} = -10 μA I _{OH} = -30 μA I _{OH} = -60 μA V _{CC} = 5V ± 10%
V _{OH1}	Output High Voltage, port 0	V _{CC} - 0.3 V _{CC} - 0.7 V _{CC} - 1.5			V V V	I_{OH} = -200 µA I_{OH} = -3.2 mA I_{OH} = -7.0 mA V_{CC} = 5V ± 10%
V _{OH2}	Output High Voltage,ALE, PSEN	V _{CC} - 0.3 V _{CC} - 0.7 V _{CC} - 1.5			V V V	I_{OH} = -100 µA I_{OH} = -1.6 mA I_{OH} = -3.5 mA V_{CC} = 5V ± 10%
R _{RST}	RST Pulldown Resistor	50	90 ⁽⁵⁾	200	kΩ	
IIL	Logical 0 Input Current ports 1, 2 and 3			-50	μΑ	Vin = 0.45V
ILI	Input Leakage Current			±10	μΑ	$0.45V < Vin < V_{CC}$
I _{TL}	Logical 1 to 0 Transition Current, ports 1, 2, 3			-650	μΑ	Vin = 2.0 V
C _{IO}	Capacitance of I/O Buffer			10	pF	Fc = 1 MHz TA = 25°C
I _{PD}	Power Down Current		20 (5)	50	μA	$2.0 \text{ V} < \text{V}_{\text{CC}} < 5.5 \text{V}^{(3)}$
I _{CC} under RESET	Power Supply Current Maximum values, X1 mode: (7)			1 + 0.4 Freq (MHz) at12MHz 5.8 at16MHz 7.4	mA	$V_{\rm CC} = 5.5 V^{(1)}$
I _{CC} operating	Power Supply Current Maximum values, X1 mode: (7)			3 + 0.6 Freq (MHz) at12MHz 10.2 at16MHz 12.6	mA	$V_{CC} = 5.5 V^{(8)}$
I _{CC} idle	Power Supply Current Maximum values, X1 mode: (7)			0.25+0.3 Freq (MHz) at12MHz 3.9 at16MHz 5.1	mA	$V_{\rm CC} = 5.5 V^{(2)}$

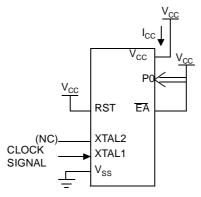


Port 0: 26 mA Ports 1, 2 and 3: 15 mA Maximum total I_{OL} for all output pins: 71 mA If I_{OL} exceeds the test condition, V_{OL} may exceed the related specification. Pins are not guaranteed to sink current greater than the listed test conditions.

- 7. For other values, please contact your sales office.
- Operating I_{CC} is measured with all output pins disconnected; XTAL1 driven with T_{CLCH}, T_{CHCL} = 5 ns (see Figure 17.), V_{IL} = V_{SS} + 0.5V,

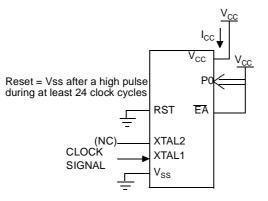
 $V_{IH} = V_{CC} - 0.5V$; XTAL2 N.C.; $\overline{EA} = Port 0 = V_{CC}$; RST = V_{SS} . The internal ROM runs the code 80 FE (label: SJMP label). I_{CC} would be slightly higher if a crystal oscillator is used. Measurements are made with OTP products when possible, which is the worst case.

Figure 13. I_{CC} Test Condition, under reset



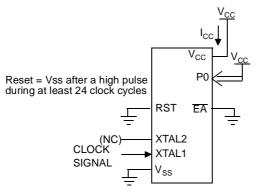
All other pins are disconnected.





All other pins are disconnected.

Figure 15. I_{CC} Test Condition, Idle Mode



All other pins are disconnected.



Table 28., Table 31. and Table 34. give the frequency derating formula of the AC parameter. To calculate each AC symbols, take the x value corresponding to the speed grade you need (-M, -V or -L) and replace this value in the formula. Values of the frequency must be limited to the corresponding speed grade:

Table 25. Max frequency for derating formula regarding the speed grade

	-M X1 mode	-M X2 mode	-V X1 mode	-V X2 mode	-L X1 mode	-L X2 mode
Freq (MHz)	40	20	40	30	30	20
T (ns)	25	50	25	33.3	33.3	50

Example:

 T_{LLIV} in X2 mode for a -V part at 20 MHz (T = 1/20^{E6} = 50 ns):

```
x= 22 (Table 28.)
```

T= 50ns

T_{LLIV}= 2T - x = 2 x 50 - 22 = 78ns

External Program Memory Characteristics

Table 26. Symbol Description

Symbol	Parameter
Т	Oscillator clock period
T _{LHLL}	ALE pulse width
T _{AVLL}	Address Valid to ALE
T _{LLAX}	Address Hold After ALE
T _{LLIV}	ALE to Valid Instruction In
T _{LLPL}	ALE to PSEN
T _{PLPH}	PSEN Pulse Width
T _{PLIV}	PSEN to Valid Instruction In
T _{PXIX}	Input Instruction Hold After PSEN
T _{PXIZ}	Input Instruction FloatAfter PSEN
T _{PXAV}	PSEN to Address Valid
T _{AVIV}	Address to Valid Instruction In
T _{PLAZ}	PSEN Low to Address Float





External Data Memory Read Cycle

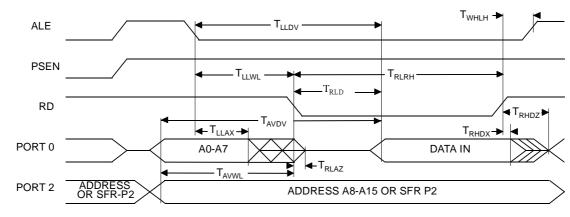


Figure 20. External Data Memory Read Cycle

Serial Port Timing - Shift Register Mode

Table 32. Symbol Description

Symbol	Parameter
T _{XLXL}	Serial port clock cycle time
T _{QVHX}	Output data set-up to clock rising edge
T _{XHQX}	Output data hold after clock rising edge
T _{XHDX}	Input data hold after clock rising edge
T _{XHDV}	Clock rising edge to input data valid

Speed	-I 40 I	M MHz		ИНz	stan mod	V dard le 40 Hz		node MHz MHz	stan mo	L dard ode MHz	Units
Symbol	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
T _{XLXL}	300		200		300		300		400		ns
T _{QVHX}	200		117		200		200		283		ns
T _{XHQX}	30		13		30		30		47		ns
T _{XHDX}	0		0		0		0		0		ns
T_{XHDV}		117		34		117		117		200	ns



Table 37. Possible Ordering Entries (Continued)

Part Number ⁽³⁾	Memory Size	Supply Voltage	Temperature Range	Max Frequency	Package	Packing
AT87C52X2-3CSUM	8K OTP	5V ±10%	Industrial & Green	40 MHz ⁽¹⁾	PDIL40	Stick
AT87C52X2-SLSUM	8K OTP	5V ±10%	Industrial & Green	40 MHz ⁽¹⁾	PLCC44	Stick
AT87C52X2-RLTUM	8K OTP	5V ±10%	Industrial & Green	40 MHz ⁽¹⁾	VQFP44	Tray
AT87C52X2-3CSUL	8K OTP	2.7 to 5.5V	Industrial & Green	30 MHz ⁽¹⁾	PDIL40	Stick
AT87C52X2-SLSUL	8K OTP	2.7 to 5.5V	Industrial & Green	30 MHz ⁽¹⁾	PLCC44	Stick
AT87C52X2-RLTUL	8K OTP	2.7 to 5.5V	Industrial & Green	30 MHz ⁽¹⁾	VQFP44	Tray
AT87C52X2-3CSUV	8K OTP	5V ±10%	Industrial & Green	60 MHz ⁽³⁾	PDIL40	Stick
AT87C52X2-SLSUV	8K OTP	5V ±10%	Industrial & Green	60 MHz ⁽³⁾	PLCC44	Stick
AT87C52X2-RLTUV	8K OTP	5V ±10%	Industrial & Green	60 MHz ⁽³⁾	VQFP44	Тгау

Notes: 1. 20 MHz in X2 Mode.

2. Tape and Reel available for SL, PQFP and RL packages

3. 30 MHz in X2 Mode.



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